



AO4818

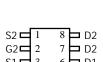
Dual N-Channel Enhancement Mode Field Effect Transistor

General Description

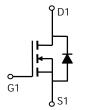
The AO4818 uses advanced trench technology to provide excellent R_{DS(ON)} and low gate charge. This device is suitable for use as a load switch or in PWM applications. Standard Product AO4818 is Pb-free (meets ROHS & Sony 259 specifications). AO4818L is a Green Product ordering option. AO4818 and AO4818L are electrically identical.

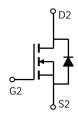
Features

$$\begin{split} &V_{DS} \; (V) = 30V \\ &I_{D} = 8.5 A \; (V_{GS} = 10 V) \\ &R_{DS(ON)} < 19 m \Omega \; (V_{GS} = 10 V) \\ &R_{DS(ON)} < 28 m \Omega \; (V_{GS} = 4.5 V) \end{split}$$



SOIC-8





Absolute Maximum Ratings T _A =25°C unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	30	V				
Gate-Source Voltage		V_{GS}	±20	V				
Continuous Drain	T _A =25°C		8.5					
Current ^A	T _A =70°C	I _D	6.6	Α				
Pulsed Drain Current ^B		I _{DM}	40					
	T _A =25°C	В	2	W				
Power Dissipation	T _A =70°C	$-P_{D}$	1.28	VV				
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C				

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\theta JA}$	48	62.5	°C/W			
Maximum Junction-to-Ambient ^A	Steady-State	κ_{θ} JA	74	110	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	35	40	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units	
STATIC F	PARAMETERS							
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$		30			V	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =24V, V _{GS} =0V				1	μА	
-033			T _J =55°C			5	μιτ	
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V				100	nA	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=250\mu A$		1	1.8	3	V	
$I_{D(ON)}$	On state drain current	V _{GS} =10V, V _{DS} =5V		40			Α	
	Static Drain-Source On-Resistance	V_{GS} =10V, I_{D} =8.5A			15.5	19	19 mΩ	
$R_{DS(ON)}$			T _J =125°C		22.3	27	11132	
		V _{GS} =4.5V, I _D =6A			23	28	mΩ	
g FS	Forward Transconductance	V _{DS} =5V, I _D =8.5A			23		S	
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V			0.75	1	V	
I_S	Maximum Body-Diode Continuous Current					3	Α	
DYNAMIC	PARAMETERS		•		•		•	
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz			1040		pF	
Coss	Output Capacitance				180		pF	
C _{rss}	Reverse Transfer Capacitance				110		pF	
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			0.7	2	Ω	
SWITCHI	NG PARAMETERS							
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =15V, I _D =8.5A			19.2	24	nC	
Q _g (4.5V)	Total Gate Charge				9.36	12	nC	
Q_{gs}	Gate Source Charge				2.6		nC	
Q_{gd}	Gate Drain Charge				4.2		nC	
t _{D(on)}	Turn-On DelayTime				5.2		ns	
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_L =1.8 Ω , R_{GEN} =3 Ω			4.4		ns	
$t_{D(off)}$	Turn-Off DelayTime				17.3		ns	
t_f	Turn-Off Fall Time				3.3		ns	
t _{rr}	Body Diode Reverse Recovery Time	I _F =8.5A, dI/dt=100A/μs			16.7		ns	
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =8.5A, dI/dt=100A/μs			6.7		nC	

A: The value of R_{0JA} is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

Rev 5: August 2005

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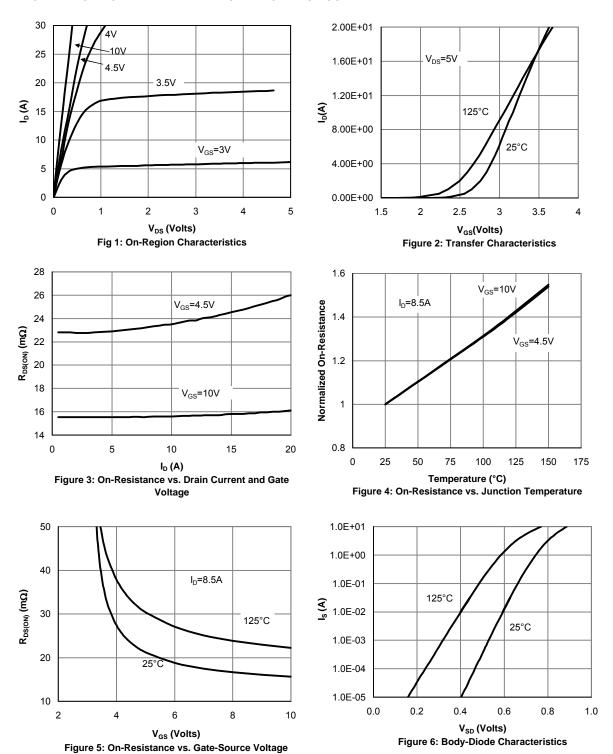
B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using $80\mu s$ pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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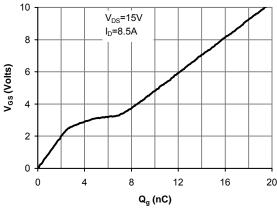


Figure 7: Gate-Charge Characteristics

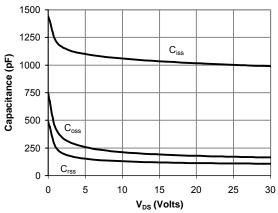


Figure 8: Capacitance Characteristics

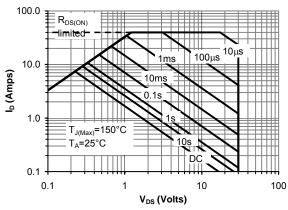


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

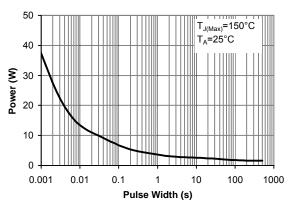


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

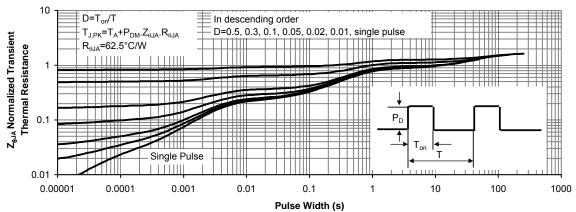


Figure 11: Normalized Maximum Transient Thermal Impedance